

Electronics assembly technology — Electronic modules

The European Standard EN 62421:2007 has the status of a
British Standard

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National foreword

This British Standard is the UK implementation of EN 62421:2007. It is identical to IEC 62421:2007.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic assembly technology.

A list of organizations represented on this committee can be obtained on request to its secretary.

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**Electronics assembly technology -
Electronic modules
(IEC 62421:2007)**

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des composants électroniques -
Modules électroniques
(CEI 62421:2007)

Montageverfahren
für elektronische Baugruppen -
Elektronikmodule
(IEC 62421:2007)

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CENELEC

European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
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Foreword

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Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 62421:2007 was approved by CENELEC as a European Standard without any modification.

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